























overall thickness = 64.85 mils

layer stackup		
dielectric	copper	layer # / description
3.15 mils	1 oz	1 top routing
10 mils	1 oz	2 GND
10 mils	1 oz	3 horizontal-routing
3.15 mils	1 oz	4 2.5V 3.3V 4V
10 mils	1 oz	5 1.25V 2.5V 3V GND CAL
10 mils	1 oz	6 vertical routing
3.15 mils	1 oz	7 GND
	1 oz	8 bottom

overall board dimensions = 100 mm * 90 mm
 plated edges: left and right
 silkscreen color = black
 soldermask color = white
 plating = ENIG